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Modeling and experimental characterization of an active MEMS based force sensor

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Abstract

Active force sensors are based on the principle of force balancing using a feedback control. They allow, unlike passive sensors, the static characterization of forces without interference of the sensor mechanical properties on the estimated stiffness of the object to be studied. This capability is fundamental when dealing with the mechanical characterization of samples having a wide range of stiffness. This paper deals with the modeling and the experimental characterization of a new active MEMS based force sensor. This sensor includes folded-flexure type suspensions and a differential comb drive actuation allowing a linear force/voltage relationship. A control oriented electromechanical model is proposed and validated experimentally in static and dynamic operating modes using a stroboscopic measurement system. This work is a first step towards new MEMS active force sensor with high resonant frequency ($>2\text{kHz}$) and high linear measurement force range ($50\text{ }\mu\text{N}$). The advantage of this structure is to be able to change the sensor operating point without changing the sensor dynamics. Thus simplifying the control law. Modifying the operating point allows performing an accurate self positioning of the probe in close proximity to the surface to be studied.

Keywords

1 Introduction

Small and embeddable force sensing tools are essential in micro-robotics [1]. The need of size reduction has led to forgo traditional engineering techniques for sensors fabrication in favor of clean room fabrication processes. The clean room facilities have enabled the production of the Micro Electro Mechanical Systems (MEMS). MEMS engineering can provide systems with much smaller details [2] than conventional techniques and can perform batch manufacturing, efficiently reducing costs and production time per unit.

MEMS force sensing can be divided into two main categories, namely elastic sensing and zero displacement sensing. The first one is the most widely reported in the literature with piezoresistive sensors [3, 4], fluidic sensors [5], capacitive sensors [6–8], MOSFET sensors [9], vision tracked sensors [10] and so on. Elastic sensors are

based on a mechanical transformation of an external force into a displacement. The force measurement is deduced from the displacement measurement by the knowledge of mechanical suspensions stiffness. This method tends to provide smaller sensors with the need of little control electronic, leading to more integrated sensors. A trade-off between the measurement range and the resolution is often involved [11]. An increase of the sensor stiffness increases its measurement range at the cost of its resolution. In order to circumvent this drawback, a mechanical structure is used in [12] to change the sensor stiffness when the applied force exceeds a threshold value. One can also design an infinite stiffness sensor, called a zero displacement sensor.

The working principle of a zero displacement sensor, also referred here as an active sensor, is to hold the position of the probe at a fixed value despite of an external applied force. This is feasible thanks to a feedback control driving a set of actuators in order to compensate the applied external force. The force measurement is deduced from the actuator voltage or current. Active sensors have also the advantage of being able to provide quantitative force measurement without an accurate calibration of the suspensions. Some of zero displacement sensors have been reported in the literature. In

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[11] and [13], the sensor is composed of an electrothermal position sensor and an electrostatic comb drive actuator. However, the use of a traditional (i.e. not differential) comb drive configuration leads to a quadratic force/voltage relationship that involves control issues for the force measurement. In [14], the zero displacement force sensor includes a piezoresistive position sensor and an additional comb drive actuator, taking advantage of the equivalent 'negative stiffness' behavior of some electrostatic actuators, to adjust in real time the resonance frequency of the sensor. Overall, passive force sensors allow for more integrated sensors and can perform adequately provided their stiffness is higher than the maximum gradient of measured forces. They are also able to perform up to 6 DOF measurements [15], while active force sensors are more fit to measure forces with a high range of gradients.

The goal of this work is to present the modeling and experimental characterization of a high bandwidth MEMS force sensor with linear force-voltage actuation, folded flexure suspensions, while being as compact as possible. A knowledge model of the sensor is proposed. Knowledge models are useful to study the influence of electromechanical parameters on the sensors performance and to have some feedback on conception.

A description of the MEMS structure is presented in Section 2. Section 3 deals with the electromechanical modeling of the sensor. The model describes the relationship between the sensor probe position and the actuation voltage of the comb drive actuator. The experimental protocol for the dynamic and the static characterization of the sensor is presented in Section 4. In Section 5 experimental data are analyzed and results are followed by several discussions.

The characterized model is used to perform some simulation as well as the synthesis on a controller for the sensor. A conclusion and future perspectives of the work finish the paper.

2 Description of the MEMS structure

The considered MEMS is presented in Fig. 1. A 2D plan and a picture of the MEMS with its PCB are presented in Fig. 2.

The sensor is composed of a differential comb drive actuator, folded-flexure suspensions, a probe and six contact pads for the electrical connections as shown in Fig. 1. The goal was the design of a force sensor with a high linear range and a bandwidth superior to 2kHz, to do so we made the choice of folded flexure suspensions. The choice of the actuator (number of comb drives and dimensions) was made so that it could be operated between -70V and 70V. The rest of the mechanical elements have been designed so that the mechanical resonant frequency fits our specifications. There are mainly 3 suspensions architectures used in MEMS devices: clamped clamped flexure, Crab-leg flexure and folded flexure design. If we consider the same flexure length and width and a force measurement in y direction, the clamped clamped suspensions have a high stiffness ratio k_x/k_y equal to the square of the ratio length/width, but the linear range of k_y is very low. The Crab-leg flexure design allows extending the linear range of k_y but significantly reduces the ratio k_x/k_y . The folded flexure design, however, increases the linear range of k_y compared to the clamped clamped design while it has the same ratio k_x/k_y as for the clamped clamped flexures. Therefore, among these

Fig. 1 3D CAD view of the MEMS based force sensor. The folded-flexure suspensions are highlighted in yellow

Fig. 2 MEMS based force sensor and enlarged view of the internal structure of the mechanical part. The movable structures are highlighted in red. Detail of one quarter of the comb drive actuator is presented above the global plan (the whole structure is 30 μm thick)

three design architectures, the folded flexure design is the best candidate when dealing with unidirectional force measurement in a wide linear operating range [16]. It has been monolithically fabricated on a silicon on insulator (SOI) wafer of 30 μm thickness. Wire bonding has been used to connect the contact pads of the MEMS to a printed circuit board (Fig. 2).

The conception has been performed in our lab using a CAD software. However, as no cleanroom facilities are available in the lab, the MEMS were realized thanks to the help of the RENATECH platform and the IEMN lab (Institut d'électronique de microélectronique et de nanotechnologie). RENATECH is a french platform of nanofabrication.

The nominal comb drive actuator includes 56 fixed fingers and 52 movable fingers, it can be seen in Fig. 2. The gap spacing between the fingers is $g = 3.5 \mu\text{m}$. The suspensions have 1 mm length and $3.5 \mu\text{m}$ width. The external part of the probe has a length of $100 \mu\text{m}$ as shown in Fig. 2. The maximum actuation voltages of the differential comb drive actuator is 70 Volts. The linear displacement range of the probe is about $50 \mu\text{m}$. The direction of motion of the probe is the y direction.

3 Dynamic modeling of the MEMS actuator

For control purposes, a dynamic model of the sensor is needed. This section deals with the electromechanical modeling of the transfer between the probe displacement and the input voltages of the differential actuator.

3.1 Electrical modeling of the differential electrostatic comb drives

Let's consider an elementary finger pair of the comb drive actuator as depicted in Fig. 3. The movable fingers are represented by the electrode (2). The fixed fingers are represented by the electrodes (1) and (3). When no voltage is applied, the MEMS is designed to have $y_1 = y_2 = y_0$, where y_1 and y_2 are the overlapping lengths between the electrodes (2) and (1) and the electrodes (2) and (3) respectively.

Hence, one can write:

$$\begin{cases} y_1 = y_0 - y_e \\ y_2 = y_0 + y_e \end{cases} \quad (1)$$

y_0 is the overlapping length when no voltage is applied and y_e is the displacement of the movable finger in y direction.

The electrostatic force exerted on the movable finger, in y direction, in response to a voltage is equal to the gradient of the electrostatic energy stored by the system.

The stored energy can be expressed as follows :

$$E = \frac{1}{2} \left(C_{12}(V_1 - V_2)^2 + C_{23}(V_2 - V_3)^2 + C_{13}(V_1 - V_3)^2 \right) \quad (2)$$

C_{ij} is the capacitance between the electrodes (j) and (i). V_i is the voltage between an electrode (i) and the electrical ground. Here, C_{13} is considered equal to 0 (the electrical coupling between electrodes 1 and 3 is neglected).

By neglecting side effects, one can get:

$$\begin{cases} C_{12} = 2(y_0 - y_e) \frac{N\epsilon_0\epsilon_r t}{g} \\ C_{23} = 2(y_0 + y_e) \frac{N\epsilon_0\epsilon_r t}{g} \end{cases} \quad (3)$$

Fig. 3 Scheme of an elementary pair of fingers in the differential comb drive actuator when the movable fingers are at the initial position $y_e = 0$ (a) and at a position $y_e \neq 0$. The movable fingers are represented by the electrode (2). The fixed fingers are represented by the electrodes (1) and (3)

$N = 26$ is the total number of mobile fingers pairs, ϵ_0 is the vacuum permittivity, ϵ_r the relative permittivity of air and $t = 30 \mu\text{m}$ the thickness of the electrodes.

Let us now consider the following gain:

$$k_c = \frac{N\epsilon_0\epsilon_r t}{g} \quad (4)$$

The electrostatic force can then be expressed as follows:

$$F = -\frac{\partial E}{\partial y_e} = k_c((V_1 - V_2)^2 - (V_2 - V_3)^2) \quad (5)$$

By setting $V_1 = -V_3$, which is thereafter used to operate the force sensor, the Eq. 5 can be simplified as follows:

$$F = 4k_c V_3 V_2 \quad (6)$$

Using the numerical value of each parameter of the electrical model, and choosing $V_3 = 40 \text{ V}$, the relationship between the electrostatic force F that drives the sensor probe and the voltage V_2 is:

$$|F| = 0.3157 V_2 [\mu\text{N}] \quad (7)$$

Fig. 4 Schematic representation of the folded-flexure suspensions. The dashed rectangle shows the quarter model of the suspensions as shown in Fig. 5

V_1 will be set at -40V and V_3 at 40V for the experiments, V_2 becoming the only control signal. The linear force/voltage relationship which is one of the main advantages of the differential comb drive actuation is therefore demonstrated.

3.2 Static mechanical modeling of the suspensions

The aim of this section is to define a knowledge based model of the static force/deflection characteristic for the suspension structure. Let us recall that folded-flexure suspensions are designed for the MEMS sensor (Fig. 1). The bodies C1, C2, and C3 (Fig. 4) are supposed to be infinitely rigid and the flexible structures will be modeled with small displacement theory.

Due to the symmetry of the structure, the problem can be reduced by considering the quarter model of the suspensions as shown in Fig. 5. The dimensions of the beam 1 and that of the beam 2 are given in Table 1.

All the displacements are considered in y direction. The displacement of the rigid body C1 will be supposed equal to the displacement of the point A of the beam 1 relatively to the point B (y_a) plus the displacement of the point C of the

beam 2 (y_c). The beam 1 will be supposed clamped at both ends and the beam 2 will be treated as simply clamped. The distance between the points B and C is equal to $18 \mu\text{m}$.

Using Euler-Bernoulli beam theory, one is able to get the following Eqs. 8 and 9.

$$y_a = \frac{Fl_1^3}{48EI} \quad (8)$$

$$y_c = \frac{Fl_2^3}{12EI} - \frac{Fl_1l_2^2}{16EI} \quad (9)$$

With E the young modulus of silicon and I the area moment of inertia of the beam in the considered direction.

By combining Eqs. 8 and 9, the total displacement of the sensor probe is

$$y_p = \frac{F}{12EI} \left(\frac{l_1^3}{4} + l_2^3 - \frac{3}{4}l_1l_2^2 \right) \quad (10)$$

The total stiffness k of the suspension structure can then be deduced from the force/displacement relationship:

$$k = \frac{y_p}{F} = \frac{12EI}{\frac{l_1^3}{4} + l_2^3 - \frac{3}{4}l_1l_2^2} \quad (11)$$

Fig. 5 Quarter model of the suspensions (Dashed rectangle in Fig. 4)

Table 1 Dimensions of the beam 1 and the beam 2 in the suspension structure

	width	thickness	length
beam1	$w = 4.5 \mu m$	$t = 30 \mu m$	$l_1 = 1 mm$
beam2	$w = 4.5 \mu m$	$t = 30 \mu m$	$l_2 = 0.965 mm$

Taking into account the dimensions of the MEMS structure and the silicon Young modulus $E = 127 \text{ GPa}$, the model (11) allows to compute $k = 1.37 \text{ N/m}$.

The static force/displacement characteristic of the suspensions has been also analyzed using a computer-aided design (CAD) software. Several finite element analysis with different forces exerted on the probe in y direction have been performed. The operating points have then been fitted to obtain the result of Fig. 6.

The finite element analysis leads to a stiffness $k=1.451 \text{ N/m}$. The difference between this result and the one obtained by the knowledge-based model is equal to 5.58 %, hence validating the hypothesis of the knowledge based model. However, both of these models consider perfect geometries, which is not necessary the case here due to the dimensions of the structure.

3.3 Electro-mechanical dynamic model of the MEMS

In the previous sections, the electrical force/voltage relationship and the static mechanical displacement/force model of the MEMS have been obtained leading to a static knowledge-based model. To extend the model into a dynamic formulation, the damping coefficient μ and the mass m of the movable structure are added here.

The dynamic equation of the movable part of the MEMS can be expressed as follows:

$$m\ddot{y}_p = -ky_p - \mu\dot{y}_p + 4k_c V_3 U \tag{12}$$

Fig. 6 Static force/displacement finite element characteristic of the suspensions

$U=V_2$ is the input of the system.

Using the Laplace transform of the Eq. 12, the transfer function $H(p)$ of the MEMS can be expressed as follows (p being the Laplace variable):

$$H(p) = \frac{y_p}{U} = \frac{4k_c V_3}{mp^2 + \mu p + k} \tag{13}$$

4 Experimental characterization

4.1 Experimental setup

As shown in Fig. 7, the experimental setup is composed of the MEMS sensor, voltage generators, a Digital Holographic Microscope (DHM) and a vibration isolation table. The DHM is used to measure the displacement of the mobile part of the MEMS in response to a voltage $U = V_2$. A beam of coherent light is emitted and focused on the MEMS. The intensity and phase of the reflected beam are recorded. The phase information is treated to get a 3D real time image of the observed structure.

4.2 Dynamic characterization of the MEMS actuator

Because of the high resonant frequency of the MEMS (relative to the DHM camera frequency), a stroboscopic unit has to be used to be able to track the position of the movable structure. For the experiment, a voltage of 40 V has been chosen for V_3 , and the actuator is driven by a square wave $U = V_2$ at 50 Hz. The stroboscope is set to get images at a frequency of 25 kHz. The first problem to solve is that the MEMS is not aligned with the microscope axes. The picture has to be rotated in order to align the movement direction with the image horizontal axis. To do so, the user selects 16 points in the image whose coordinates are known a priori. Then, 32 vectors are extracted from the 16 points.

Fig. 7 Experimental setup for the characterization of the MEMS sensor. The stroboscopic unit is under the table

Let A be the matrix containing the vector of coordinates in the image and B the matrix containing the vector of the a priori coordinates such that $B = R \times A$:

$$A = \begin{bmatrix} x_{a1} & y_{a1} \\ x_{a2} & y_{a2} \\ \vdots & \vdots \\ x_{an} & y_{an} \end{bmatrix}, B = \begin{bmatrix} x_{b1} & y_{b1} \\ x_{b2} & y_{b2} \\ \vdots & \vdots \\ x_{bn} & y_{bn} \end{bmatrix}$$

The determination of R can be seen as an overdetermined system of equations. That means that no matrix R is solution of this equation. However several solutions exist to provide a matrix R that minimizes a cost function of $B - RA$. Here, the cost function will be quadratic. The chosen matrix R will be:

$$R = B \times \text{pinv}(A) \quad (14)$$

Where $\text{pinv}(\cdot)$ is the Moore-Penrose pseudoinverse [17].

The rotation angle and scale ratio are extracted from R . The image is first rotated, missing pixels are recovered by a linear interpolation between neighboring points. The image is in grayscale, so pixels intensities range from 0 (black) to 255 (white). Pixels intensities are summed along the rotated image vertical axis. Figure 8 represents the sum of pixels intensities for one position of the MEMS probe. Similarly, Fig. 9 shows the same sum for several positions of the probe.

Let's consider the red curve in ROI represented by the dashed rectangle of Fig. 8 for a fixed position of the MEMS. The horizontal axis represents a pixel number in the horizontal direction. The vertical axis represents the sum of the intensities of the pixels that have the same horizontal position. This shape is characteristic of the probe. Around this shape, the intensity is constant, hence the corresponding

offset can be removed, so the center of mass of the shape can be computed using Eq. 15 after removing the corresponding intensity offset. When the probe moves horizontally, the shape moves along with it by the same amount (with some distortion due to image blur). Therefore, the displacement of the probe can be estimated as the displacement of the center of mass of the ROI.

$$y_0 = \frac{\sum_{ROI} y \times (I(y)^4)}{\sum_{ROI} (I(y)^4)} \quad (15)$$

$I(y)$ is the sum of the intensities of all the pixels that share the coordinate y i.e. vertical sum of the intensities on y , it is taken at the power four to increase the detection accuracy. y can be expressed either as pixel number or converted to a position in microns using the scale ratio extracted from Eq. 14. Pattern tracking and data correlation are rendered impossible here due to high movement noise.

This method has been used to measure the step response of the MEMS probe experimentally (Fig. 10). These signals resulted in the identification of a second order model $H_i(p)$ describing the dynamic behavior of the MEMS. The step response of the model for a 4.5 Volts step input is also shown in Fig. 10.

The transfer function has been identified using MATLAB "system identification toolbox" on the system step response with $V_3 = 40V$. It was performed looking for a transfer function model of order 2 with no zeroes. The identified transfer function $H_i(p)$ is:

$$H_i(p) = \frac{0.842 \times 10^8}{p^2 + 774.6p + 1.818 \times 10^8} \quad (16)$$

Fig. 8 Top view of the MEMS with the DHM and example of curve showing vertical sum of pixels for a fixed position of the probe

Its input and output are expressed in Volts and μm respectively. The resonant frequency of this model is 2.2 kHz. This value is coherent with the one obtained through the finite element analysis of the MEMS. Bode plot of the identified transfer function is displayed in Fig. 11.

4.3 Static characterization of the MEMS actuator

The MEMS static characterization is essential to check the system linearity. To do so, the setup described in Section 4.2 is used. The system input is chosen to be sine wave at 5 Hz. The position is recorded and plotted with respect to the input voltage. Result is shown in Fig. 12.

This curve can be modeled by first order polynomial. The experimental static gain of the MEMS is equal to $0.51 \mu\text{m}/\text{V}$. The static gain deduced from the fitted transfer function is $0.463 \mu\text{m}/\text{V}$. Figure 12 shows a characteristic that can be assimilated as hysteresis. However, as this nonlinearity is not described in the literature as being

specific to electrostatic MEMS, we assume that this phenomenon is not mainly due to a hysteresis and could be due to some motion blur. Even though, this behavior is not predominant and can be neglected in the modeling. The non linearity error is lower than $0.4 \mu\text{m}$ once measurement artifacts have been removed, this error can be due to image noise or outside vibrations. Experimental results differ by a factor 2 from the ones presented in [18] because of a faulty amplifier in the original setup which introduced an amplification 2 times higher than expected.

5 Simulation and test of the sensor in closed loop

5.1 Sensor simulation

Now that the system transfer function has been characterized, a controller has to be designed for the sensor to operate in active mode. For the test in simulation to be possible, the coefficients of Eq. 13 have to be identified. However Eq. 16 only allows the identification of three of the four parameters. Because of this one of the four parameters has to be

Fig. 9 Vertical sum of pixels for different values of displacements of the sensor probe (extreme values are shown with their legend)

Fig. 10 Experimental and simulation step response of the MEMS sensor for a 4.5 Volts step input

Fig. 11 Bode plot of the MEMS identified transfer function

Fig. 13 Simulated force position characteristic of a 0.1N/m stiffness spring (blue) and estimated characteristic with the proposed sensor in passive mode (red)

identified by other means. There is little way to obtain m and ν with enough accuracy, so either k or $4k_c V_3$ has to be taken from the knowledge model. Between both $4k_c V_3$ is chosen.

$$4k_c V_3 = 0.316\mu\text{N/V} \quad (17)$$

This leads to :

$$\begin{aligned} m &= 3.7 \times 10^{-9}\text{kg} = 3.7\mu\text{g} \\ \nu &= 2.8 \times 10^{-6}\text{N/m} \times s \\ k &= 0.68\text{N/m} \end{aligned} \quad (18)$$

The difference between finite element analysis result and the identified k can be explained by several causes :

- The value of $k_c V_3$ is highly sensitive to the mechanical parameters of the comb drive, and the manufacturing processes can lead to some dimensions inaccuracies. Moreover the side effects (such as the capacitance between the finger front end and the part of fixed electrode in front of it) were neglected when computing the values of C_{12} and C_{23} and these hypothesis can not be entirely true [19].
- Finite element analysis at these scales is prone to errors as the geometries are supposed to be perfect and the materials are supposed to be homogeneous. However Deep Reactive Ion Etching often creates defects that are far from negligible at these scales.

Fig. 12 Experimental static characteristic of the MEMS sensor

5.2 Differences between passive and active modes

In passive mode, the sensor isn't actuated, any force applied on the sensor tip is translated into a displacement of the mobile part. In our case the displacement could be recorded thanks to a laser interferometer or by capacitive reading [20]. This mode only requires the identification of the flexures stiffness and is faster to implement than the active mode. However the sensor linearity depends on the flexure stiffness as well as the position measurement linearity. Furthermore, with this mode of operation, when trying to obtain force-position characteristics, the estimation is altered by the stiffness of the sensor flexures. In Fig. 13 are displayed the simulated force position characteristic of a spring with 0.1N/m stiffness acquired with the proposed sensor in passive mode only knowing the sensor position, as well as the actual characteristic.

One can notice a slight difference between the estimated and real force position characteristic. This is caused by the estimation of the characteristic of the spring in serial with the flexures equivalent spring. To compensate for this problem several solutions are possible :

- use a stiffer force sensor,
- subtract probe displacement from the sensor position,
- use the sensor in active mode.

Using the sensor in active mode can provide the advantage of having a virtually infinite stiffness and to measure far greater forces than would be allowed by the mobile part maximum displacement. First a controller has to be designed for the sensor, to do so, a PID controller has been implemented in simulation and fitted using Matlab PID tuner. During the design the constraints where a phase margin of 60° and a bandwidth of $5 \times 10^5\text{rad.s}^{-1}$ for the system in closed loop. The chosen bandwidth is of the same order of magnitude as the system resonant frequency as increasing it further would not improve the sensing performance. Figure 14, shows the normalized step response of the sensor with and without the controller. Position of

Fig. 14 Simulated normalized position of the sensor's probe in open loop (red) and in closed loop (blue)

Fig. 16 Experimental probe displacement (blue) and simulation result (orange) for a step reference of $2\mu m$

the sensor's probe and PID output when a force of $10\mu N$ is applied to the sensor are displayed in Fig. 15. On this curve one can notice a slight transient behavior of the sensor. However, this transient displacement is inferior to the sensor maximum displacement ($20\mu m$) thus allowing for the estimation of forces superior to the ones measurable in passive mode. furthermore, once steady state is reached the sensor mobile part is kept at its initial position.

5.3 Experimental test of the sensor

The actual experimental setup lacks the ability to measure the displacement of the sensor's probe in real time. Consequently, to validate the simulation results and the controller that has been synthesized, a simulation is run with the model of the sensor and the controller output is recorded. This record is played in a loop in order to be able to perform a stroboscopic analysis similar to the one performed in Section 4.2. However, the actual experimental setup lacks the capability to play the data at a sufficient speed. To be able to test the validity of the proposed MEMS model, a discrete time PID has been designed for the sensor with a 10kHz sampling frequency, with design requirements of a 2ms closed loop response and a 60° phase margin. The closed loop response time

Fig. 15 Simulated probe displacement (blue) and active sensor reading (red) for an applied force of $10\mu N$

is a compromise between system speed and the likeness of having undetectable oscillations between samples. The resulting sensor trajectory is displayed in Fig. 16, alongside with the predicted results. The results show the sensor's ability to reach a position of $2\mu m$, which corresponds, based on the value of k deduced from the transfer function, to a force of $1.36\mu N$.

The experimental results fit the simulation results reasonably well, the discrepancies can be explained by the measurement noise due to the image motion blur.

6 Conclusion

Based on a differential comb drive actuator and a folded-flexure suspension, a new MEMS force sensor is proposed in this paper. By design, its suspension is arranged to constrain the sensor probe within a single direction. Whilst, the differential actuator is chosen to provide a linear force/voltage relationship where force and probe position are independent. Furthermore, because of the suspension linearity, the sensor can be used as a force-sensing positioner with $\pm 20\mu m$ displacement range, while retaining its mechanical performance independently from the operating point. In view of using a zero displacement principle (balance principle), a control oriented electromechanical model is driven. Preliminary experimental characterization validates this model in static and dynamic operating modes using a stroboscopic measurement system. The sensor shows a promising potential with a high bandwidth and a great linear force measurement range, thus allowing for future work on the measurement of forces with great dynamics. Furthermore, because of the zero displacement sensing, this sensor is usable for the measure of forces with high gradients without compromises on its resolution or accuracy. The simulations results have shown the possibility to control the sensor in active mode.

Future work will focus on the sensor control in real time by the use of a laser interferometer and the sensor

calibration, as well as the controller implementation with analog components. This sensor will be used for instance to measure the stiffness of muscular cells in order to differentiate cancerous cells from healthy ones.

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